

Docket No.: 251148US0



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION: Yuko UCHIMARU, et al.

SERIAL NO.: 10/809,704

FILED: March 26, 2004

FOR: LOW DIELECTRIC CONSTANT INSULATING MATERIAL AND SEMICONDUCTOR
DEVICE USING THE MATERIAL

LETTER SUBMITTING REPLACEMENT DRAWING SHEETS

COMMISSIONER FOR PATENTS
Alexandria, VA 22313

SIR:

Responsive to the below indicated communication, the following drawing sheets are submitted herewith:

- ☒ 17 Replacement Drawing Sheets ☐ _____ New Drawing Sheets
- ☐ Official Action dated _____
- ☐ Notice of Allowance/Issue Fee dated _____
- ☒ NOTICE TO FILE MISSING PARTS dated JUNE 14, 2004

The changes and/or modifications made include the following:

The attached Replacement Drawing Sheets have been corrected as required. Figs.: 2, 3, 5, 6, 7, 8, 9, 10, 11, 12, 18, 19, 21 and 23 have been translated into English. The characters within the Fig. 8 are now legible. The following Figs. 2, 3, 11, 12, 13, 14, 18, 20, 21 and 22 are submitted herewith on the appropriate paper.

Respectfully Submitted,

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